

N7618D

100V N-Channel POWER MOSFET

1. FEATURES

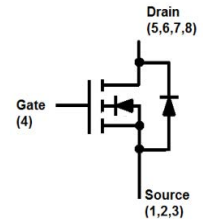
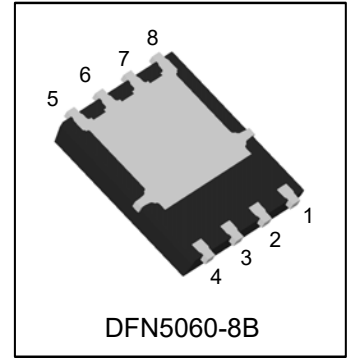
- High Speed Power Switching
- We declare that the material of product compliance with RoHS requirements and Halogen Free.

2. APPLICATIONS

- Portable appliances
- Power management

3. DEVICE MARKING AND RESISTOR VALUES

Device	Marking	Shipping
N7618D	LN7618	3000/Tape&Reel



4. MAXIMUM RATINGS(Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-to-Source Voltage		VDS	100	V
Gate-to-Source Voltage		VGS	±20	V
Continuous Drain Current	TC=25°C	ID	56	A
	TC=100°C		27	A
Pulsed Drain Current		IDM	200	A
Avalanche Current		IAS	12	A
Avalanche energy L=0.1mH		EAS	7.2	mJ
Power Dissipation(TC=25° C)		PD	62.5	W
Operating Junction and Storage Temperature Range		Tj/Tstg	-55~+150	°C

5. THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Thermal Resistance,Junction-to-Ambient	RθJA	62	°C/W
Thermal Resistance,Junction-to-Case	RθJC	2	

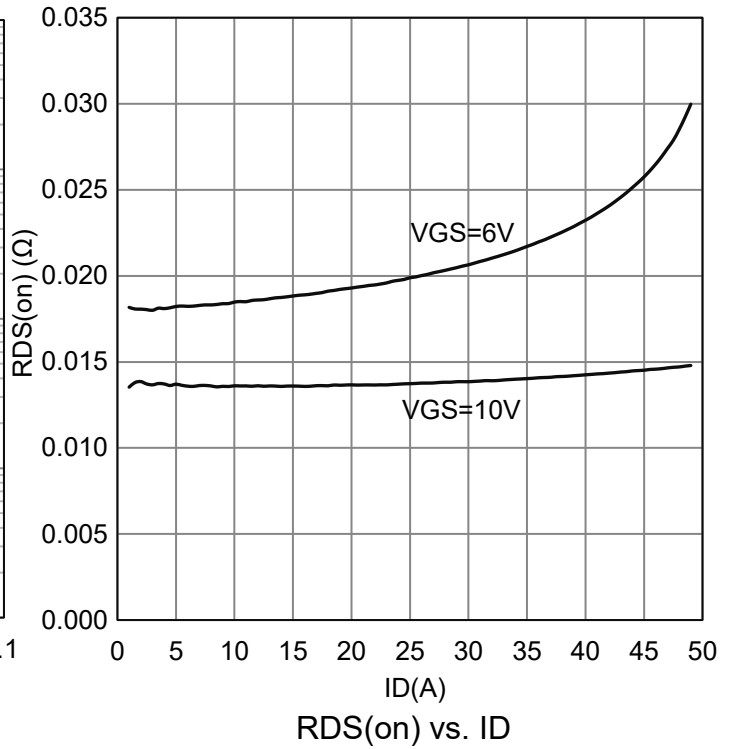
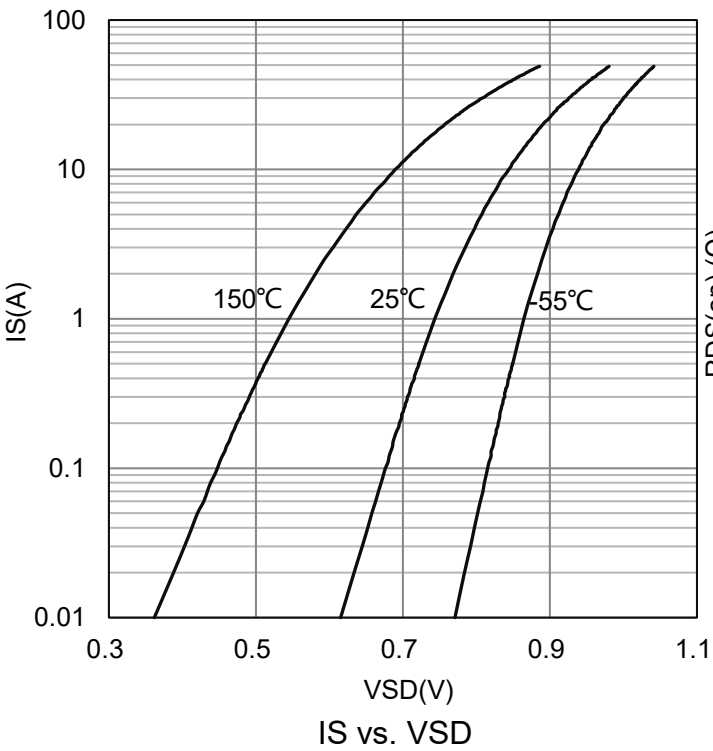
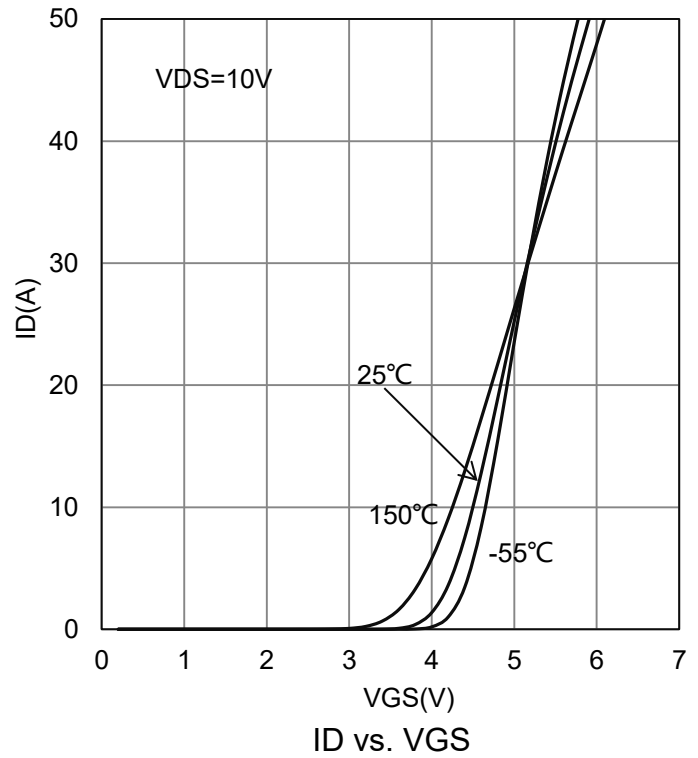
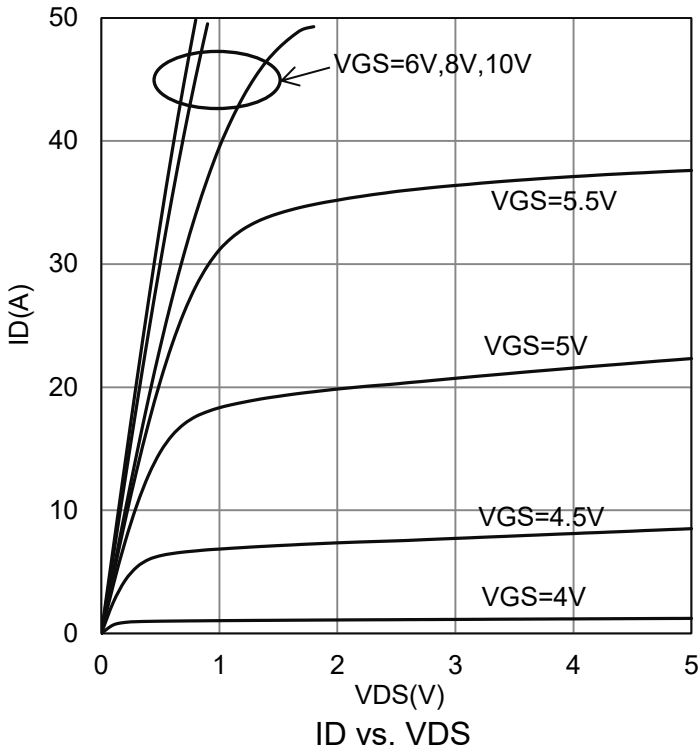
1.Repetitive Rating : Pulsed width limited by maximum junction temperature.

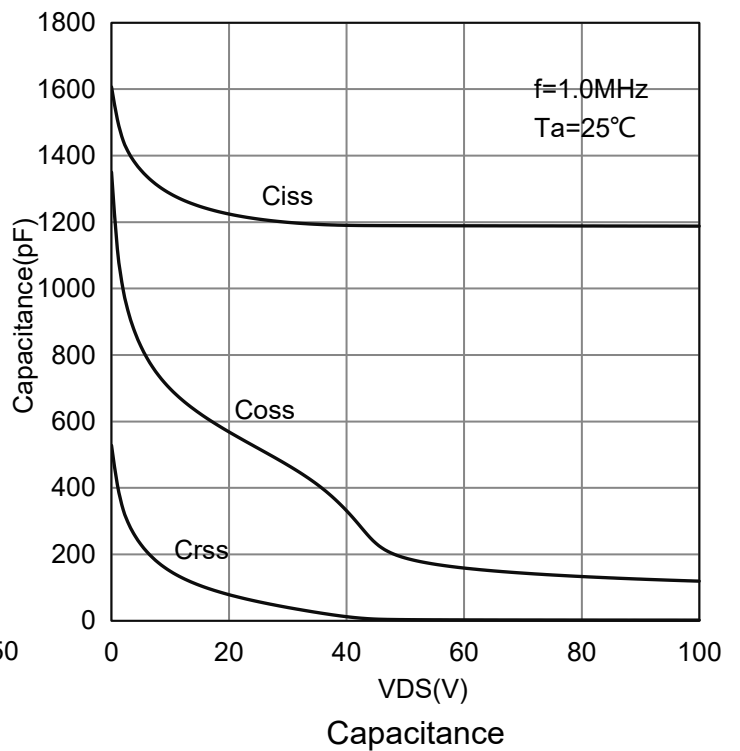
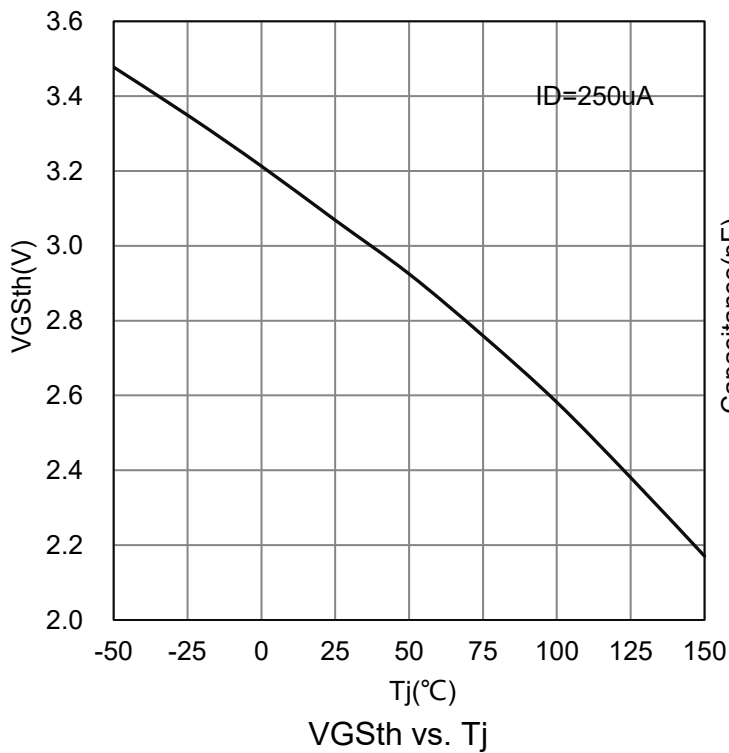
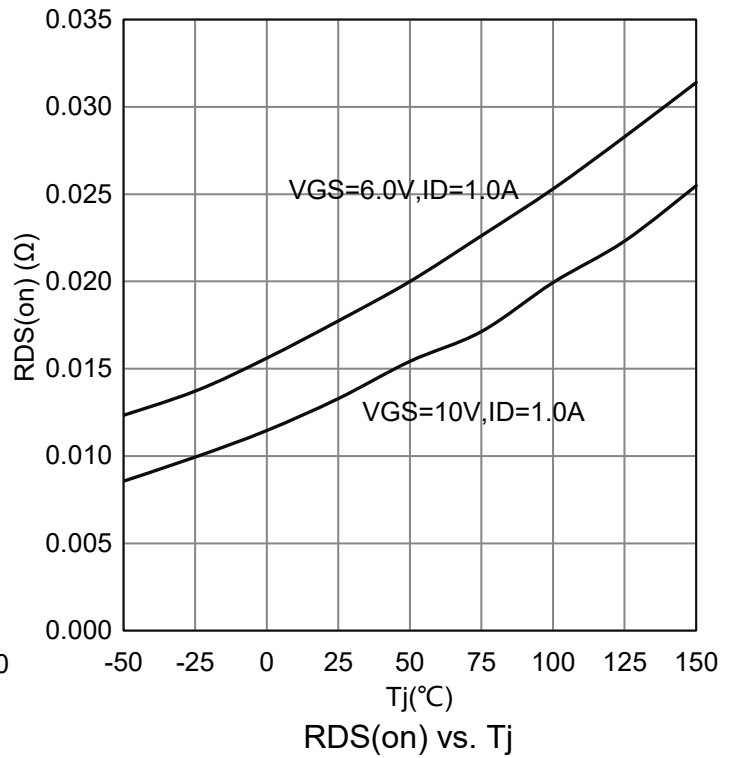
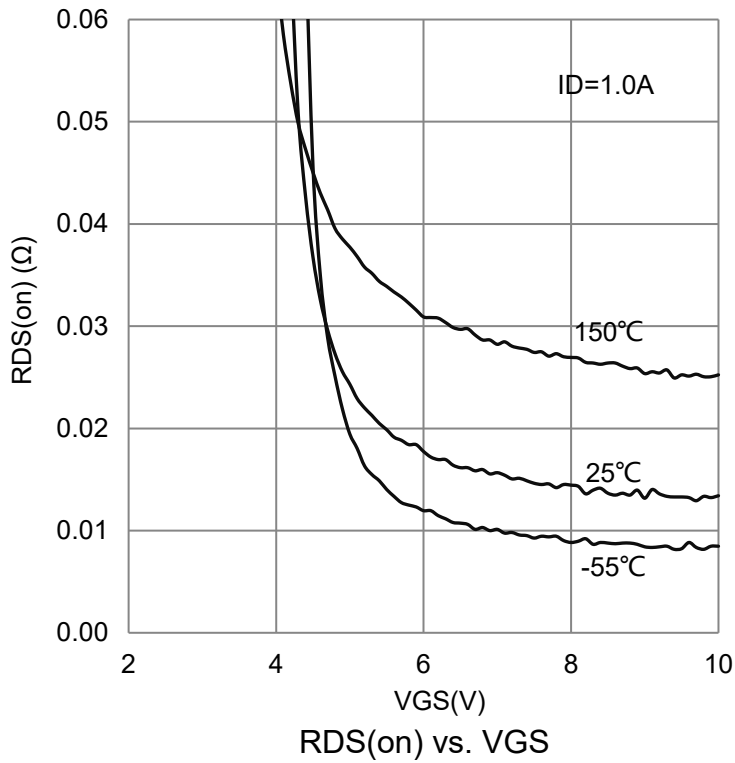


6. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

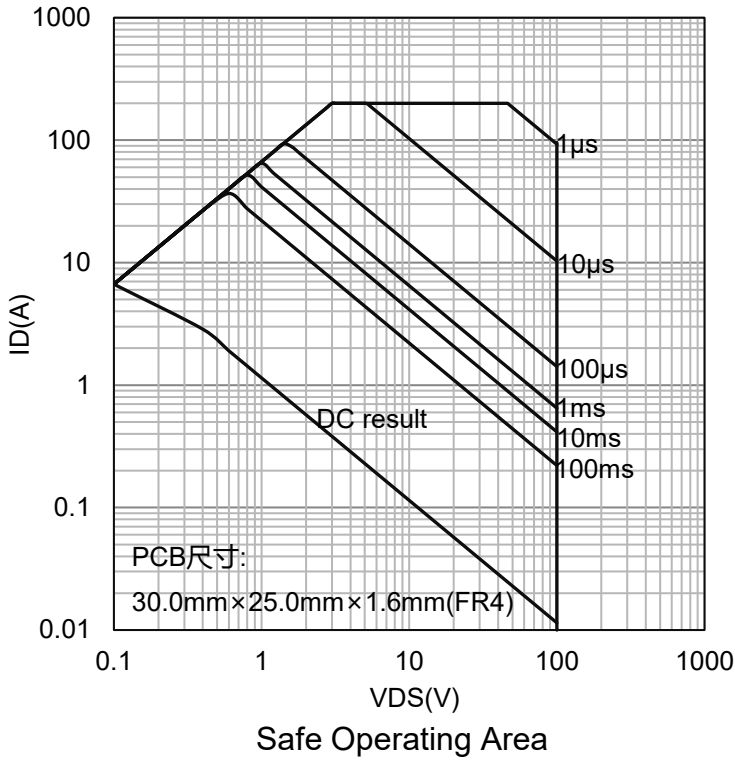
Characteristic	Symbol	Min.	Typ.	Max.	Unit				
Drain-Source Breakdown Voltage (VGS =0V, ID =250μA)	BVDSS	100	-	-	V				
Gate-Source Threshold Voltage (VDS = VGS , ID = 250μA)	VGS(th)	2	3	4	V				
Gate-Body leakage current (VDS =0V, VGS = ±20V)	IGSS	-	-	±100	nA				
Drain-Source Leakage Current (VDS = 80 V, VGS = 0 V)	IDSS	-	-	1	μA				
Drain-to-Source On-Resistance (VGS =10V, ID =1A) (VGS =6V, ID =1A)	RDS(ON)	- -	13 19	15 24	mΩ				
Gate Resistance (VDS=0V,VGS=0V,f=1.0MHz)	Rg	-	60	-	Ω				
Total Gate Charge	(VDS =50V , VGS =10V , ID =1A)	-	24	-	nC				
Gate to Source Charge						Qgs	-	4.2	-
Gate to Drain Charge						Qgd	-	10	-
Input Capacitance	(VGS = 0V ,VDS = 50V, f = 1MHz)	-	1189	-	pF				
Output Capacitance						Coss	-	189	-
Reverse Transfer Capacitance						Crss	-	3.5	-
Turn-on Delay Time	(VDD =50V , VGS =10V , RG =6Ω ,ID =1A)	-	14.2	-	nS				
Rise Time						td(on)	-	20.8	-
Turn-Off Delay Time						tr	-	42	-
Fall Time						td(off)	-	30	-
Diode Forward Voltage (IS =1A, VGS =0V)	VSD	-	0.7	1.3	V				

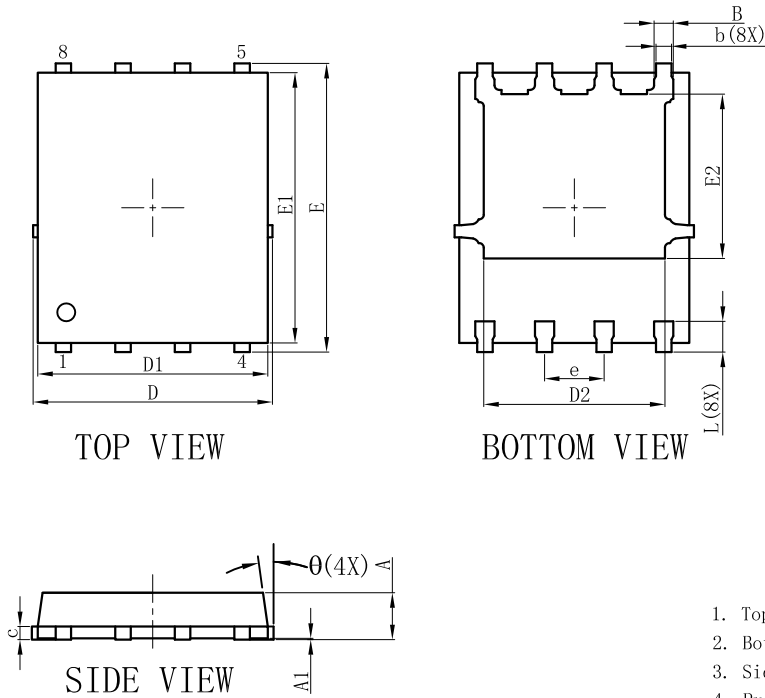


7. ELECTRICAL CHARACTERISTICS CURVES


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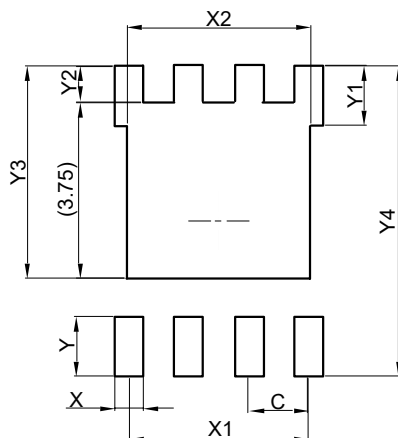


8. OUTLINE AND DIMENSIONS
DFN5060-8B


DFN5060-8B			
DIM	MIN	NOR	MAX
A	0.90	1.00	1.10
A1	0.00	0.02	0.05
E	6.00	6.15	6.30
E1	5.66	5.76	5.86
E2	3.40	3.50	3.60
D	4.95	5.10	5.25
D1	4.80	4.90	5.00
D2	3.76	3.86	3.96
b	0.30	0.35	0.40
B	0.36	0.41	0.46
L	0.56	0.66	0.76
e	1.27BSC		
c	0.254REF.		
θ	0°	-	12°
All Dimensions in mm			

GENERAL NOTES

1. Top package surface finish Ra0.4±0.2um
2. Bottom package surface finish Ra0.7±0.2um
3. Side package surface finish Ra0.4±0.2um
4. Protrusion or Gate Burrs shall not exceed 0.05mm per side.
5. Off-center Max0.038mm; Mismatch Max 0.038mm.

9. SOLDERING FOOTPRINT


DFN5060-8B	
DIM	(mm)
C	1.27
X	0.61
X1	3.81
X2	3.91
Y	1.27
Y1	1.27
Y2	0.77
Y3	4.52
Y4	6.61

